

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4714733

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SONGLING HUANG	11/03/2017
XIAOCHUN SONG	11/03/2017
GONGTIAN SHEN	11/03/2017
WEI ZHAO	11/03/2017
JUNMING LIN	11/03/2017
YIHUA KANG	11/03/2017
YU ZHANG	11/03/2017
SHEN WANG	11/03/2017

RECEIVING PARTY DATA

Name:	HUBEI UNIVERSITY OF TECHNOLOGY
Street Address:	NANLI RD. 28
Internal Address:	HONGSHAN DISTRICT, HUBEI
City:	WUHAN
State/Country:	CHINA
Postal Code:	430068
Name:	TSINGHUA UNIVERSITY
Street Address:	QINGHUAYUAN
Internal Address:	HAIDIAN DISTRICT
City:	BEIJING
State/Country:	CHINA
Postal Code:	100084
Name:	CHINA SPECIAL EQUIPMENT INSPECTION AND RESEARCH INSTITUTE
Street Address:	XIYUAN NO. 2, HEPING ST.
Internal Address:	CHAOYANG DISTRICT
City:	BEIJING
State/Country:	CHINA
Postal Code:	100029
Name:	EDDYSUN (XIAMEN) ELECTRONIC CO., LTD.
Street Address:	WANGHAI RD. 23
Internal Address:	RUANJIANYUAN, FUJIAN

PATENT

City:	XIAMEN
State/Country:	CHINA
Postal Code:	361003
Name:	HUAZHONG UNIVERSITY OF SCIENCE AND TECHNOLOGY
Street Address:	LUOYU RD. 1037
Internal Address:	HONGSHAN DISTRICT, HUBEI
City:	WUHAN
State/Country:	CHINA
Postal Code:	430074

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15829586

CORRESPONDENCE DATA

Fax Number: (716)819-4787

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 716-856-4000

Email: ipdocketing@hodgsonruss.com

Correspondent Name: HODGSON RUSS LLP

Address Line 1: 140 PEARL STREET

Address Line 2: SUITE 100

Address Line 4: BUFFALO, NEW YORK 14202-4040

ATTORNEY DOCKET NUMBER: PIOE3172887US

NAME OF SUBMITTER: CHARLES S. RAUCH

SIGNATURE: /charles s rauch/

DATE SIGNED: 12/01/2017

Total Attachments: 2

source=PIOE3172887US-Assignment#page1.tif

source=PIOE3172887US-Assignment#page2.tif

ASSIGNMENT OF INVENTION

WHEREAS, we, **HUANG, Songling**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **SONG, Xiaochun**, Nanli Rd. 28, Hongshan District, Wuhan, Hubei 430068, China; **SHEN, Gongtian**, Xiyuan No. 2, Heping St. Chaoyang District, Beijing 100029, China; **ZHAO, Wei**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, **LIN, Junming**, Wanghai Rd. 23, Ruanjianyuan, Xiamen, Fujian 361003, China; **KANG, Yihua**, Luoyu Rd. 1037, Hongshan District, Wuhan, Hubei 430074, China; **ZHANG, Yu**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; and **WANG, Shen**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, have invented certain new and useful improvements in a **METHOD FOR COMPRESSING AND RECONSTRUCTING DATA**, for which an application for Letters Patent in the United States is being filed, claiming priority to Chinese Patent Application No. 201611121562.7 filed on December 08, 2016;

AND WHEREAS, **Hubei University of Technology**, Nanli Rd. 28, Hongshan District, Wuhan, Hubei 430068, China; **Tsinghua University**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **China Special Equipment Inspection and Research Institute**, Xiyuan No. 2, Heping St. Chaoyang District, Beijing 100029, China; **Eddysun (Xiamen) Electronic Co., Ltd.**, Wanghai Rd. 23, Ruanjianyuan, Xiamen, Fujian 361003, China; and **Huazhong University of Science and Technology**, Luoyu Rd. 1037, Hongshan District, Wuhan, Hubei 430074, China, are desirous of acquiring all interest in said invention, said application, and in any Letters Patent which may be granted therefor;

AND WHEREAS, at the time the invention was made, we were under an obligation to assign all of our right, title, and interest in said invention to Hubei University of Technology, Tsinghua University, China Special Equipment Inspection and Research Institute, Eddysun (Xiamen) Electronic Co., Ltd., and Huazhong University of Science and Technology.

NOW THIS INDENTURE WITNESSETH, that for the sum of one dollar and other valuable consideration to us in hand paid, the receipt of which is hereby acknowledged, we hereby assign, sell, and transfer unto said Hubei University of Technology, Tsinghua University, China Special Equipment Inspection and Research Institute, Eddysun (Xiamen) Electronic Co., Ltd., and Huazhong University of Science and Technology our entire right, title, and interest in said invention, said application, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights, rights under the International Convention For The Protection Of Industrial Property, rights under the Patent Cooperation Treaty, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Letters Patent to said Hubei University of Technology, Tsinghua University, China Special Equipment Inspection and Research Institute, Eddysun (Xiamen) Electronic Co., Ltd., and Huazhong University of Science and Technology as the assignees of the whole right, title, and interest thereto.

And we further agree to sign and properly execute such necessary and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and for obtaining any reissue or reissues of any Letters Patent which may be granted for our aforesaid invention, as the assignees thereof shall hereafter require and prepare at their own expense.

WITNESS, our signature and date of execution:

Huang Songling
HUANG, Songling

Song Xiaochun
SONG, Xiaochun

Shen Gongtian
SHEN, Gongtian

Zhao Wei
ZHAO, Wei

Lin Junming
LIN, Junming

Kang Yihua
KANG, Yihua

Zhang Yu
ZHANG, Yu

Wang Shen
WANG, Shen

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date

03/11/2017
Date